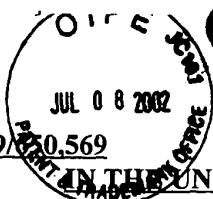


S/N 09/050,569



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Joseph E. Geusic et al. Examiner: Julio Maldonado  
Serial No.: 09/650,569 Group Art Unit: 2823  
Filed: August 30, 2000 Docket: 303.390US3  
Title: METHOD OF FORMING AN OPTICAL FIBER INTERCONNECT THROUGH  
A SEMICONDUCTOR WAFER

**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Commissioner for Patents  
Washington, D.C. 20231

Applicant has reviewed the Office Action mailed on April 2, 2002. Please amend the  
above-identified patent application as follows.

**IN THE SPECIFICATION**

Please make the paragraph substitutions indicated in the appendix entitled Clear Version  
of Amended Specification Paragraphs. The specific changes incorporated in the substitute  
paragraphs are shown in the following marked-up versions of the original paragraphs:

**Paragraph 1 on page 1 is amended as follows:**

This application is a Continuation of U.S. application, Serial No. 09/031,975, filed on  
February 26, 1998, now U.S. Patent No. 6,150,188.

**REMARKS**

Applicant has carefully reviewed and considered the Office Action mailed on April 2,  
2002, and the references cited therewith.

Claims 39-72 are pending in this application.

**Information Disclosure Statement**

Applicant respectfully requests that copies of the 1449 Forms, listing all references that  
were submitted with the Supplemental Information Disclosure Statements filed on November 13,  
2001 and March 18, 2002, marked as being considered and initialed by the Examiner, be returned  
with the next official communication.

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JUL 15 2002  
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